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- (54) **Title:** LIFT PIN ASSEMBLY

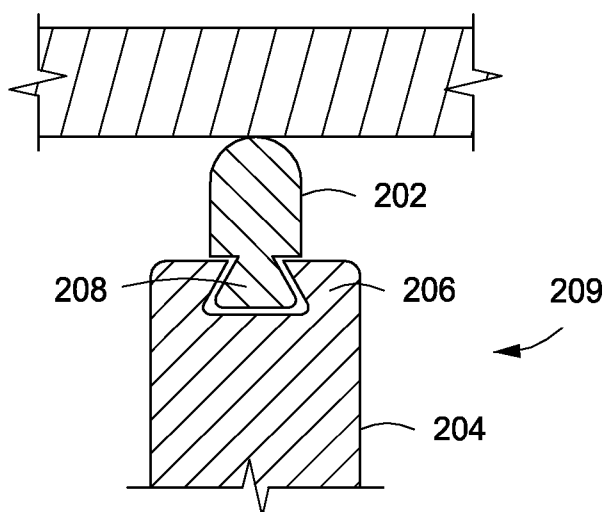


FIG. 2

- (57) **Abstract:** Embodiments of lift pin assemblies are
provided herein. In some embodiments, a lift pin assembly in-
cludes an elongate base formed of a first material and having
a first feature formed in a distal end of the base to interface
with and removably support a tip; and a tip formed of a
second material different than the first material and having a
support surface on a first side of the tip and an opposing
second side of the tip, wherein the opposing second side in-
cludes a second feature to mate with the first feature of the
base to removably retain the tip on the distal end of the base.



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